Document Number: STCV27W800CY4V Preliminary Datasheet V1.1

GaN HEMT 50V, 800W, 2.3-2.7GHz Full band RF Power Transistor

Description

The STCV27W800CY4V is a 800-watt, internally matched GaN HEMT, designed for 5G cellular applications with frequencies from 2.3-2.7GHz, **enabled by wide band VBW capability to support IBW typically 200MHz**..

It can be configured as asymmetrical Doherty for 4G or 5G application, delivering 100W average power, according to normal 9dB back off.

There is no guarantee of performance when this part is used in applications designed Outside of these frequencies.

Typical Doherty Pulsed CW and 1C W--CDMA Characterization Performance:

VDD = 50 Vdc, IDQA = 300 mA, VGSB = -5Vdc,1C WCDMA; Signal PAR = 10 dB @ 0.01% Probability on CCDF.

Frog	Pulse CW Signal(1)			Pavg=50.0dBm WCDMA Signal(2)			
Freq	P1	P1	P3	P3	C= (4D)	F# (0/)	ACDDEM (4D-)
(GHz)	(dBm)	(W)	(dBm)	(W)	Gp (dB)	Eff (%)	ACPR5M (dBc)
2.32	50.65	116	60.05	1010	14.37	50.90	-25.50
2.40	50.67	116	60.21	1050	14.59	50.62	-27.20
2.50	50.49	112	60.52	1125	14.79	49.93	-30.14
2.60	51.56	143	60.12	1023	14.93	49.75	-34.80
2.65	50.08	102	59.46	882	14.58	49.79	-33.55

Applications

- Asymmetrical Doherty amplifier within N41 5G band and B40 4G band
- S band power amplifier

Important Note: Proper Biasing Sequence for GaN HEMT Transistors

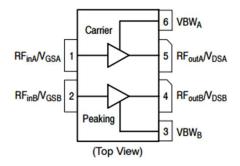
Turning the device ON

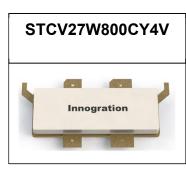
- 1. Set VGS to the pinch—off (VP) voltage, typically –5 V
- 2. Turn on VDS to nominal supply voltage
- 3. Increase VGS until IDS current is attained
- 4. Apply RF input power to desired level

Turning the device OFF

- 1. Turn RF power off
- 2. Reduce VGS down to VP, typically -5 V
- 3. Reduce VDS down to 0 V
- 4. Turn off VGS

Figure 1: Pin Connection definition





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Document Number: STCV27W800CY4V Preliminary Datasheet V1.1

Table 1. Maximum Ratings

Rating	Symbol	Value	Unit
Drain—Source Voltage	V _{DSS}	+200	Vdc
Gate—Source Voltage	V _{GS}	-8 to +0.5	Vdc
Operating Voltage	V _{DD}	55	Vdc
Maximum gate current	lgs	116	mA
Storage Temperature Range	Tstg	-65 to +150	°C
Case Operating Temperature	T _C	+150	°C
Operating Junction Temperature	TJ	+225	°C

Table 2. Thermal Characteristics

Characteristic	Symbol	Value	Unit
Thermal Resistance, Junction to Case by FEA	Po IC	0.65	°C /W
T _C = 85°C, Pout=100W, 2.6GHz Doherty application board	R _θ JC	0.65	

Table 3. Electrical Characteristics (TA = 25℃ unless otherwise noted)

DC Characteristics (main path, measured on wafer prior to packaging)

Characteristic	Conditions	Symbol	Min	Тур	Max	Unit
Drain-Source Breakdown Voltage	VGS=-8V; IDS=56mA	V _{DSS}		200		V
Gate Threshold Voltage	VDS =10V, ID = 56mA	$V_{GS(th)}$	-4		-2	V
Gate Quiescent Voltage	VDS =50V, IDS=300mA, Measured in Functional Test			-3.2		V

DC Characteristics (peak path, measured on wafer prior to packaging)

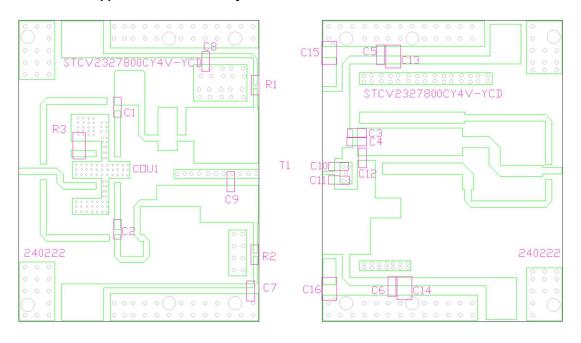
Characteristic	Conditions	Symbol	Min	Тур	Max	Unit
Drain-Source Breakdown Voltage	VGS=-8V; IDS601mA	V _{DSS}		200		V
Gate Threshold Voltage	VDS =10V, ID = 60mA	$V_{GS(th)}$	-4		-2	V
Gate Quiescent Voltage	escent Voltage VDS =50V, IDS=400mA Measured in Functional Test			-3.2		V

Ruggedness Characteristics

Characteristic	Conditions	Symbol	Min	Тур	Max	Unit
Load mismatch capability	2.6GHz, Pout=100W WCDMA 1					
	Carrier in Doherty circuit	VCMD		40.4		
	All phase,	VSWR		10:1		
	No device damages					

Document Number: STCV27W800CY4V Preliminary Datasheet V1.1

Figure 3: Picture of application board Doherty circuit for 2.3-2.7GHz



Part	Quantity	Description	Part Number	Manufacture
C1,C2	6	10pFHigh Q	251SHS100BSE	TEMEX
C5, C6,C7,C8		Capacitor		
C3,C4	2	3.9pFHigh Q	251SHS3R9BSE	TEMEX
		Capacitor		
C10,C11	2	1.6pFHigh Q	251SHS1R6BSE	TEMEX
		Capacitor		
C9	1	1.5pFHigh Q	251SHS1R5BSE	TEMEX
		Capacitor		
C12	1	5.1pFHigh Q	251SHS5R1BSE	TEMEX
		Capacitor		
C13,C14, C15,C16	4	10uF MLCC	RS80R2A106M	MARUWA
R1,R2	2	10 Ω Power	ESR03EZPF100	ROHM
		Resistor		
R3	1	51 Ω Power	RFR50-20CT0421B	YT
		Resistor		
COU1	1	2 dB Bridge	DC2500P02	YT
T1	1	800W GaN	STCV27W800CY4V	Innogration
		Dual Transistor		



Figure 4: Efficiency and power gain as function of Pout

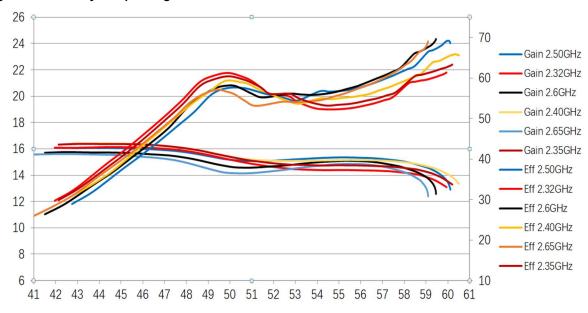
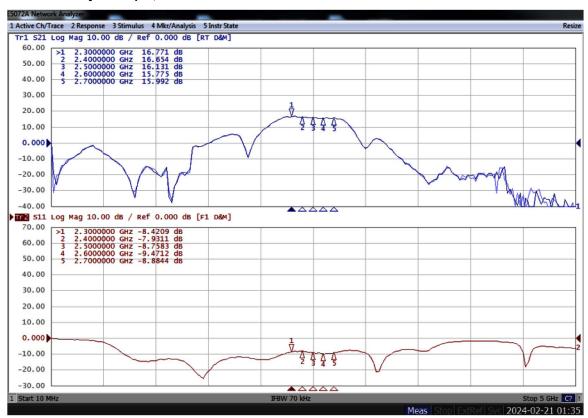


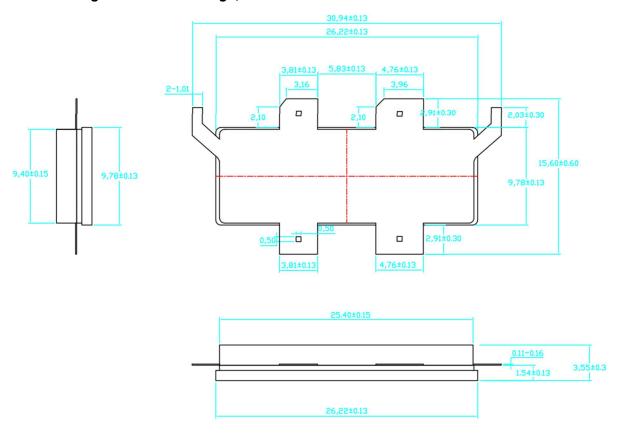
Figure 5: Network analyzer output, S11 and S21



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Document Number: STCV27W800CY4V Preliminary Datasheet V1.1

Earless Flanged Ceramic Package; 6 leads- CY4V



Revision history

Table 4. Document revision history

Date	Revision	Datasheet Status		
2023/12/18	V1.0 Preliminary Datasheet Creation			
2024/2/22	V1.1	Modify according to the latest application result		

Application data based on LWH-23-26/24-08

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